

650V N-CHANNEL ENHANCEMENT MODE MOSFET

MAIN CHARACTERISTICS

I _D	20A	
V _{DSS}	650V	
R _{DSON} -typ(@V _{GS} =10V)	<0.5Ω (Type:0.37 Ω)	

Features

♦Fast Switching

♦Low ON Resistance

♦Low Gate Charge

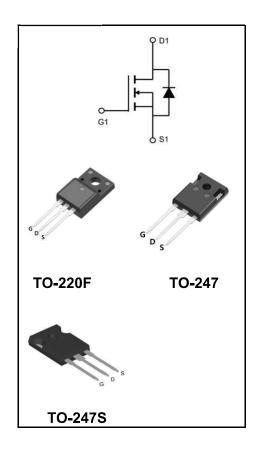
♦100% Single Pulse avalanche energy Test

♦LeadfreeincomplywithEURoHS2011/65/EUdirectives

Mechanical Data

♦Case: Molded plastic ♦Mounting Position: Any

Molded Plastic: UL Flammability Classification Rating 94V-0
Solder bath temperature275°C maximum,10s per JESD22-106



Product Specification Classification

Part Number	Package	Marking	Pack
YFW20N65AF	TO-220F	YFW 20N65AF XXXXX	50PCS/Tube
YFW20N65AP	TO-247	YFW 20N65AP XXXXX	30PCS/Tube
YFW20N65APS	TO-247S	YFW 20N65APS XXXXX	30PCS/Tube





Maximum Ratings at Tc=25°C unless otherwise specified

Chamadariation	Cumb ala	Val	l luita			
Characteristics	Symbols	220F	247/247S	- Units		
Drain-Source Voltage	V _{DS}	650		650		V
Gate-Source Voltage	V _{GS}	±30		V		
Continue Drain Current	lo –	20		Α		
-Continuous (TC = 100°C)	ID	13				
Pulsed Drain Current (Note1)	Ірм	80		80		A
Power Dissipation	PD	85	230	w		
-Derate above 25°C	PD	0.65 0.58		W/°C		
Single Pulse Avalanche Energy (Note2)	Eas	1250		mJ		
Avalanche Current (Note 1)	I AR	20		A		
Repetitive Avalanche Energy (Note 1)	Eas	37		mJ		
Operating Temperature Range	Tu	150		°C		
Storage Temperature Range	Тѕтс	-55 to +150		°C		
Thermal Resistance, Junction to Case	Rejc	1.47	0.5	°C/W		
Thermal Resistance, Junction to Ambient	Reja	62.5	48.5	°C/W		

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Тур	Max	Units
Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	BV _{DSS}	650	-	-	V
	V _{DS} = 650 V, V _{GS} = 0 V		-	-	1	- uA
Drain-Source Leakage Current	V _{DS} = 520 V, T _C = 125°C	520 V, T _c = 125°C	-	-	10	
Gate Leakage Current	V _{GS} = ± 30 V, VDS = 0 V	I _{GSS}	-	-	±100	nA
Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	V _{GS(th)}	2	-	4	V
Drain-Source On-State Resistance	V _{GS} = 10 V, I _D = 10A	R _{DS(on)}	-	0.37	0.5	Ω
Forward Transconductance	V _{DS} = 40 V, I _D = 10 A	gfs	-	18	-	S
Input Capacitance	V _{GS} = 0 V, V _{DS} = 25 V, f = 1MHz	C _{iss}	-	2567	-	
Output Capacitance		Coss	-	290	-	рF
Reverse Transfer Capacitance		C _{rss}	-	20	-	
Turn-on Delay Time		td(ON)	-	39	-	
Rise Time	$I_D = 20, V_{DD} = 325V,$ $R_G=10\Omega(Note3,4)$	tr	-	80	-]
Turn-Off Delay Time		td(OFF)	-	94	-	- nS
Fall Time		tf	-	63	-	
Total Gate Charge		$\mathbf{Q}_{\mathbf{G}}$	-	65	-	
Gate to Source Charge	$I_D = 20 \text{ A}, V_{DD} = 520 \text{ V}, V_{GS} = 10 \text{ V(Note3,4)}$	Q _{GS}	-	14	-	nC
Gate to Drain Charge	35 11 ((11111,1)	\mathbf{Q}_{GD}	-	24	-	



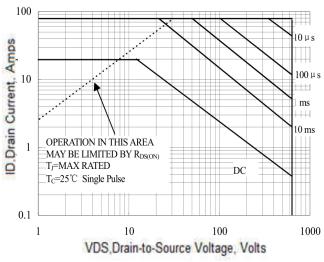
Source-Drain Diode Characteristics at Ta=25°C unless otherwise specified

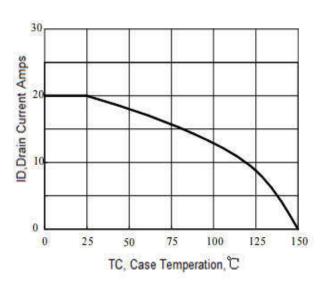
Characteristics	Test Condition	Symbols	Min	Тур	Max	Units
Maximun Body-Diode Continuous Current		Is	-	-	20	Α
Maximun Body-Diode Pulsed Current		I _{SM}	-	-	80	Α
Drain-Source Diode Forward Voltage	I _{SD} =20A	V _{SD}	-	-	1.4	V
Reverse Recovery Time	I _{SD} = 20A, V _{GS} = 0 V, dI _F / dt = 100 A/μs(Note3)	trr	-	630	-	nS
Reverse Recovery Charge		Qrr	-	7.4	-	uC

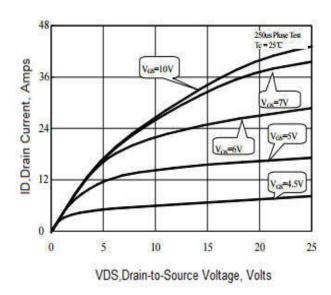
Note:

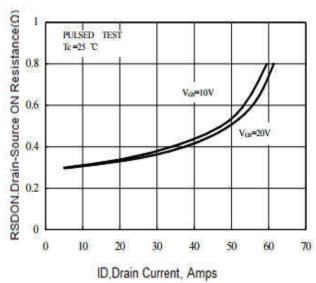
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. IAS = 20A, VDD = 50 V, L =6mH, RG = 25Ω , starting TJ = 25° C.
- 3. ulse test: Pulse Width ≤300 µ s, Duty Cycle≤2%.
- 4. Essentially Independent of Operating Temperature.

Ratings and Characteristic Curves



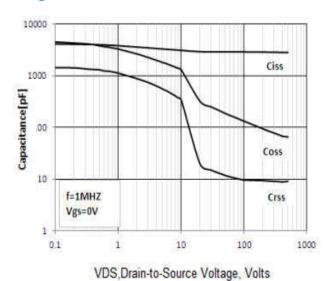


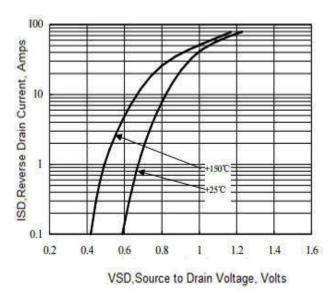


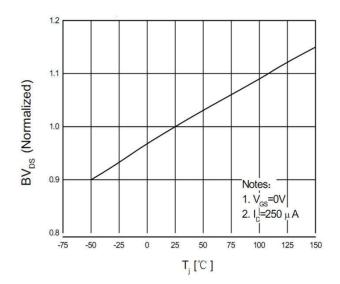


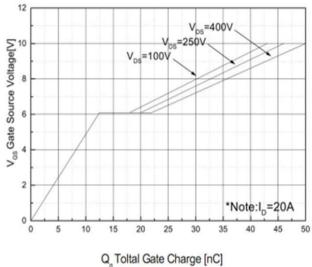


Ratings and Characteristic Curves





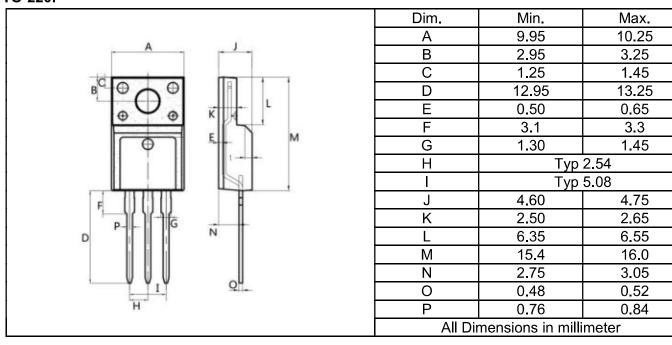




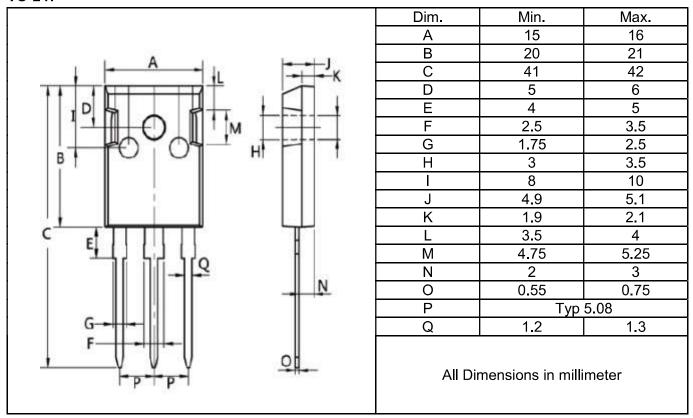


Package Outline Dimensions Millimeters

TO-220F



TO-247

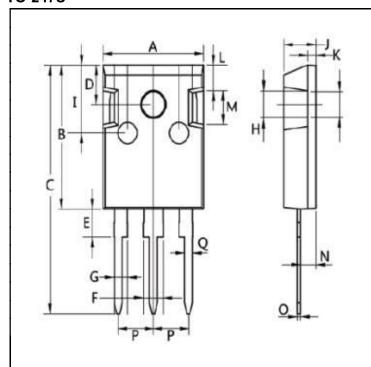






Package Outline Dimensions Millimeters

TO-247S



Dim.	Min.	Max.	
Α	15	16	
В	19.5	20.5	
С	33.5	35.5	
D	5	6	
E	3.5	4.5	
F	2.5	3.5	
G	1.75	2.5	
Н	3	4	
1	9	11	
J	4.9	5.1	
K	1	1.3	
L	3.75	4.25	
М	4.75	5.25	
N	1.8	2.2	
0	0.45	0.6	
Р	Typ 5.08		
Q	1.2	1.3	
All Dimensions in millimeter			

单击下面可查看定价,库存,交付和生命周期等信息

>>YFW(佑风微)